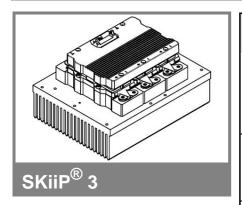
SKiiP 1813GB123-3DL



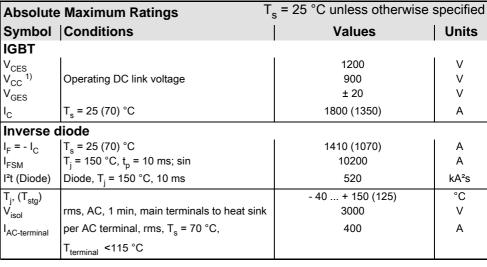
2-pack-integrated intelligent Power System

Power Section SKiiP 1813GB123-3DL

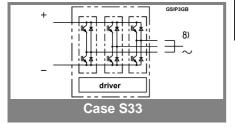
Data

Power section features

- SKiiP technology inside
- Trench IGBTs
- CAL HD diode technology
- · Integrated current sensor
- Integrated temperature sensor
- Integrated heat sink
- IEC 60721-3-3 (humidity) class 3K3/IE32 (SKiiP[®] 3 System)
- IEC 60068-1 (climate) 40/125/56
- UL recognized file no. E63532
- with assembly of suitable MKP capacitor per terminal
- 8) AC connection busbars must be connected by the user; copper busbars available on request



Characteristics			T _s = 25 °C unless otherwise specified						
Symbol	Symbol Conditions			min.	typ.	max.	Units		
IGBT	•								
V _{CEsat}	I _C = 900 A, T _j measured at termin	= 25 (125 nal) °C;			1,7 (1,9)	2,1	V	
V_{CEO}	$T_i = 25 (125)^\circ$	°C; at term	ninal			0,9 (0,8)	1,1 (1)	V	
r_{CE}	$T_i = 25 (125)$		ninal			0,9 (1,3)	1,3 (1,6)	mΩ	
I _{CES}	$V_{GE} = 0 \text{ V}, V_{C}$ $T_{i} = 25 (125)^{\circ}$					3,6 (108)		mA	
E _{on} + E _{off}	$I_{\rm C}^{\rm J}$ = 900 A, $V_{\rm C}$	cc = 600 V	/			331		mJ	
	T _j = 125 °C, V	_{CC} = 900	V			585		mJ	
R _{CC+EE}	terminal chip,	T _i = 25 °C)			0,17		mΩ	
L _{CE}	top, bottom	,				4		nΗ	
C _{CHC}	per phase, AC	C-side				5,1		nF	
Inverse	diode								
$V_F = V_{EC}$	I _F = 900 A, T _j measured at termin	= 25 (125 nal) °C			1,5 (1,5)	1,8	V	
V_{TO}	T _i = 25 (125) °	C.				0,9 (0,7)	1,1 (0,9)	V	
r _T	$T_i = 25 (125)^\circ$					0,7 (0,9)	0,8 (1)	mΩ	
E _{rr}	$I_{\rm C} = 900 \rm A, V_{\rm C}$	_{CC} = 600 V	/			63		mJ	
	T _j = 125 °C, V	_{CC} = 900	V			84		mJ	
Mechani	cal data							•	
M _{dc}	DC terminals,	SI Units			6		8	Nm	
M _{ac}	AC terminals,				13		15	Nm	
W	SKiiP® 3 Syste	em w/o he	eat sink			2,4		kg	
w	heat sink					7,5		kg	
Thermal characteristics (PX 16 heat sink with fan SKF 16B-230-1); "s" reference to heat sink; "r" reference to built-in temperature sensor (acc. IEC 60747-15)									
$R_{th(j-s)I}$	per IGBT						0,02	K/W	
R _{th(j-s)D}	per diode						0,038	K/W	
Z _{th}	R _i (mK/W) (ma	ax. values	s)			tau _i (s)			
	1	2	3	4	1	2	3	4	
$Z_{th(j-r)I}$		9,6	7	0	363	0,18	0,04	1	
Z _{th(j-r)D}		12	18	20	30	5	0,25	0,04	
7	2.4	20	E	1 1	210	0.5	11	0.4	



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1,4

210

85

11

0,4

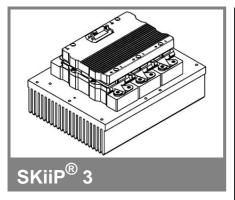
20

5,5

2,1

 $Z_{th(r-a)}$

SKiiP 1813GB123-3DL



2-pack-integrated intelligent Power System

2-pack integrated gate driver SKiiP 1813GB123-3DL

Data

Gate driver features

- · CMOS compatible inputs
- Wide range power supply
- Integrated circuitry to sense phase current, heat sink temperature and

DC-bus voltage (option)

- Short circuit protection
- Over current protection
- Over voltage protection (option)
- Power supply protection against under voltage
- Interlock of top/bottom switch
- · Isolation by transformers
- Fibre optic interface (option for GB-types only)
- IEC 60068-1 (climate) 40/85/56
- UL recognized file no. 242581

Absolute	Maximum Ratings T	T _a = 25 °C unless otherwise specified			
Symbol	Conditions	Values	Units		
V_{S2}	unstabilized 24 V power supply	30	V		
V_{i}	input signal voltage (high)	15 + 0,3	V		
dv/dt	secondary to primary side	75	kV/μs		
V_{isollO}	input / output (AC, rms, 2)	3000	V		
V _{isoIPD}	partial discharge extinction voltage, rms, Q _{PD} ≤10 pC;	1170	V		
V _{isol12}	output 1 / output 2 (AC, rms, 2 s)	1500	V		
f _{sw}	switching frequency	10	kHz		
f _{out}	output frequency for I _{peak(1)} =I _C	10	kHz		
$T_{op} (T_{stg})$	operating / storage temperature	- 40 + 85	°C		

Characte	eristics	(T _a = 25 °C			
Symbol	Conditions	min.	typ.	max.	Units
V_{S2}	supply voltage non stabilized	13	24	30	V
I _{S2}	V _{S2} = 24 V	278+37*f/kHz+0,00015*(I _{AC} /A) ²			mA
V _{iT+}	input threshold voltage (High)			12,3	V
V_{iT-}	input threshold voltage (Low)	4,6			V
R _{IN}	input resistance		10		kΩ
C_{IN}	input capacitance		1		nF
t _{d(on)IO}	input-output turn-on propagation time		1,3		μs
$t_{d(off)IO}$	input-output turn-off propagation time		1,3		μs
$t_{pERRRESET}$	error memory reset time	9			μs
t_{TD}	top / bottom switch interlock time		3,3		μs
I _{analogOUT}	max. 5mA; 8 V corresponds to 15 V supply voltage for external components		1800		А
I _{s1out}	max. load current			50	mA
I _{TRIPSC}	over current trip level				
	(I _{analog} OUT = 10 V)		2250		Α
T_tp	over temperature protection	110		120	°C
U _{DCTRIP}	U_{DC} -protection ($U_{analog OUT} = 9 V$);	i	not mplemented	d	V
	(option for GB types)				

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